

Forward-Looking Statements



This document may contain forward-looking statements regarding the business, results of operations, financial condition and earnings outlook of AIXTRON. These statements may be identified by words such as "may", "will", "expect", "anticipate", "contemplate", "intend", "plan", "believe", "continue" and "estimate" and variations of such words or similar expressions. These forward-looking statements are based on the current assessments, expectations and assumptions of the executive board of AIXTRON, of which many are beyond control of AIXTRON, based on information available at the date hereof and subject to risks and uncertainties. You should not place undue reliance on these forward-looking statements. Should these risks or uncertainties materialize or should underlying expectations not occur or assumptions prove incorrect, actual results, performance or achievements of AIXTRON may materially vary from those described explicitly or implicitly in the relevant forward-looking statement. This could result from a variety of factors, such as those discussed by AIXTRON in public reports and statements, including but not limited those reported in the chapter "Risk Report". AIXTRON undertakes no obligation to revise or update any forward-looking statements as a result of new information, future events or otherwise, unless expressly required to do so by law.

Due to rounding, numbers presented throughout this report may not add up precisely to the totals indicated and percentages may not precisely reflect the absolute figures for the same reason.

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AIXTRON - Q1/2025 Key highlights





Financials Q1/2025: Robust Q1 in a soft market environment

- Order Intake with EUR 132m above prior year and expectations (Q1/2024: EUR 120m)
- Revenues with EUR 113m exceeded upper end of guided range; weaker demand from western players compensated by Asian/Chinese customers
- Gross Profit at EUR 34m; Gross Margin at 30%; ☐ impacted by EUR ~5m expense for personnel reduction in operations area;
- <u>EBIT at EUR 3m</u>; EBIT Margin at 3% ∫ adjusted Gross Margin at 35%



Geopolitical dynamics monitored closely

- As of today Semiconductor Equipment remains exempt from US tariffs
- Potential longer-term effects not predictable at this point in time
- Management is monitoring developments closely to initiate corrective measures if necessary



FY/2025 Guidance¹ confirmed

- Revenues FY/25E: EUR 530m 600m; Q2/25E: EUR 120m EUR 140m
- Gross Margin FY/25E: 41% 42% ☐ incl. EUR ~5m expense for headcount reduction in operations area;
- EBIT Margin FY/25E: 18% 22%; will result in similar amount of annualized savings corresponding to ~1ppt higher Margins



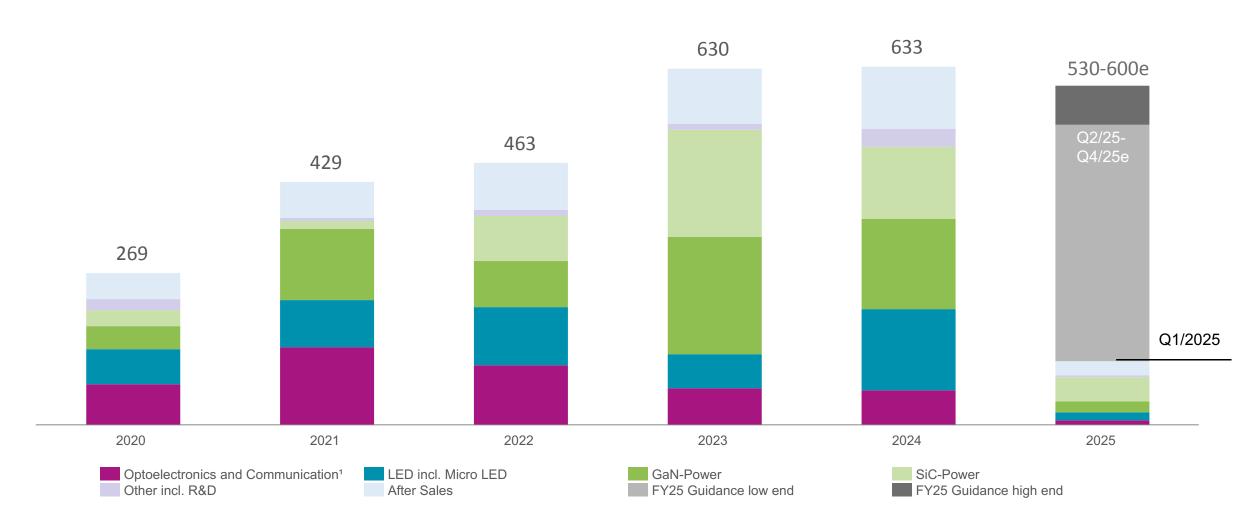
Structural growth drivers fully intact - but visibility on FY/2025 remains low

- Demand in end markets currently still weak
- GaN/SiC-power expected roughly flat yoy; LED/Micro LED revenues weaker yoy
- Optoelectronics with some promising developments

Annual Revenues by Application



EUR million



Q1/2025 – Highlights | Key P&L Indicators



	Revenues	Gross Profit	Margin	EBIT	Margin
Q1	€ 112.5 m -5% YoY	€ 34.1 m -22% YoY	30%	€ 3.3 m -67% YoY	3%



- Gross Profit & EBIT both impacted by the EUR ~5m one-off for personnel measure in operations area
- Adjusted Gross Margin at 35%
- Gross Margin yoy impacted by less favorable product mix and selected product enhancements in connection with the ramp-up of the G10 series
- Q1 Opex cost yoy down mainly due to ~23% lower R&D cost

Q1/2025 - Highlights | Key Balance Sheet & Cash Flow Indicators



	Working Capital ¹	Operating Cash Flow	Free Cash Flow	Cash Balance ²
Q1	€ 414.7 m € -31.5 m vs. Q4/24	€ 35.1 m € +42.5 m YoY	€ 29.8 m € +62.9 m YoY	€ 93.3 m € +28.7 m vs. Q4/24



- Inventory reduction continued; further positive impact expected throughout 2025
- Operating cash flow positively impacted by reduction in working capital
- Capex in Q1/2025 significantly reduced yoy
- FCF with strong improvement due to reduction of working capital & capex

¹ Working Capital = Inventories + Trade Receivables - Trade Payables - Contract Liabilities for Advance Payments; FX-effects excluded in illustrated Change in Working Capital 2 Including other current financial assets

We address a comprehensive set of growth applications with our G10 family of products



Power Electronics



SiC Power

- EV main inverters and EV OBCs
- EV charging infrastructure
- Data centers: AC/DC
- Wind & PV
- Traction & large drives

SiC GaN

AsP

GaN

AsP

GaN Power & RF

- Fast charging / mobile devices
- Data centers: AC/DC & DC/DC
- Motor drives, e.g. white goods
- Al power delivery
- EV OBCs
- Base stations



Optoelectronics / LEDs



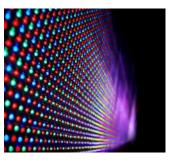


Lasers

- Optical data communication
- 3D sensing
- LiDAR
- Industrial power lasers

Micro LEDs / Specialty LEDs

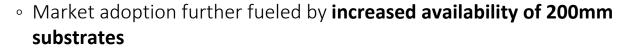
- Industrial displays (in/outdoor)
- TVs
- Smart watches / AR glasses
- Automotive
- Horticulture

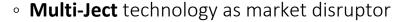




G10-SiC – tool of record for low cost SiC Epitaxy & best in class at material uniformity



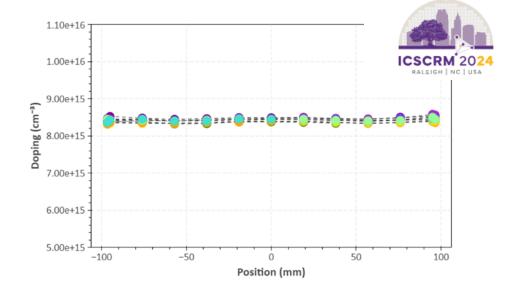




- Enables very long epi campaigns without recipe change
- Now enabling material uniformities
 better than Single Wafer performance reference points







Lab results presented at ICSCRM '24 showing 200mm SiC doping uniformity of (Max-Min)/mean $\pm 0.6 - 0.9\%$

GaN power – growth is fueled by adding more and more applications

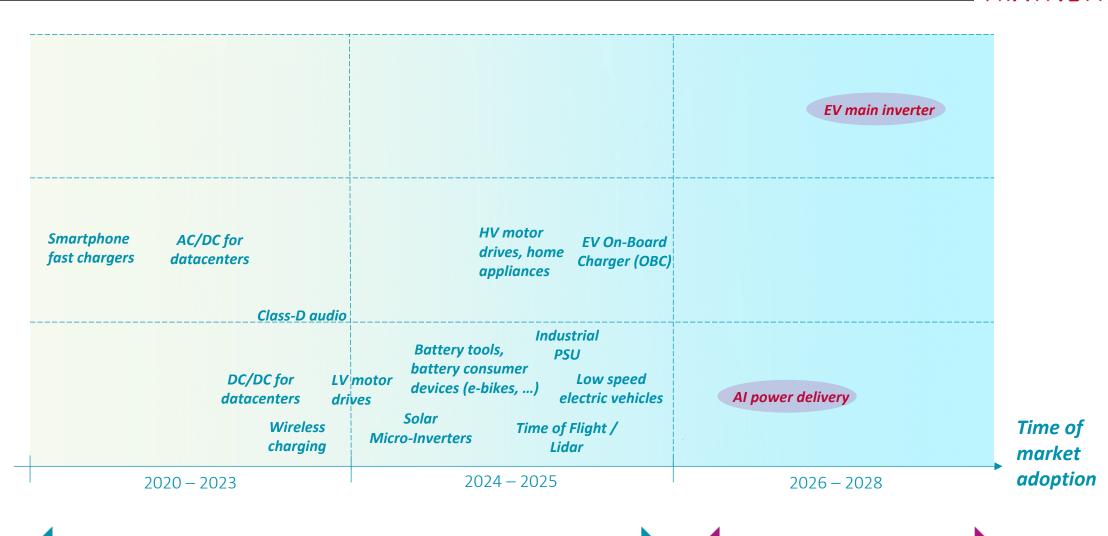




> 1200 V

500-700 V

< 200 V



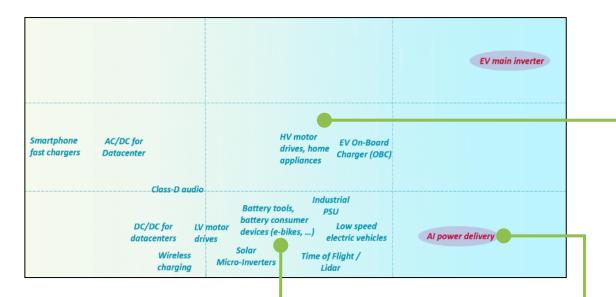
Applications (mostly) captured by analysts

Not captured by analysts



GaN power – selected case examples





HV motor drives, home appliances



- Up to 40% energy consumption reduction
- Ramp from 2025 onwards
- High unit volume, large dies
 --> high wafer consumption

Battery tools and consumer devices





- Longer battery life
- Smaller size and reduced weight b/c less cooling

Al "On Board" power delivery



- Replacement of silicon power chips around the GPUs
- Up to 50% lower power loss in a compact form factor
- ~30-60% upside to today's
 GaN market models

AIXTRON Innovation Center in Herzogenrath (Germany)









- Total invest of EUR ~100 million
- 1,000m² additional cleanroom space
- Allows for collaboration and co-development with customers
- Designed and built for 300mm technology

Opened in December 2024 - Full operation for 300mm GaN started in Q1/25

AIXTRON – Guidance for Q2/2025 and FY/2025

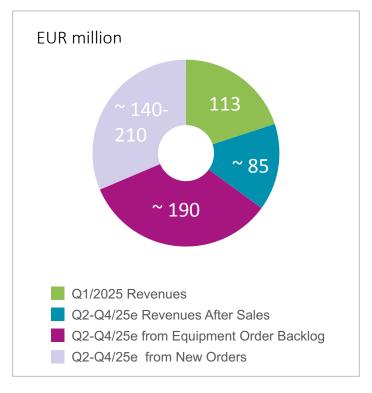


FUR million

Guidance ¹	Q2/2025 ¹	FY/2025 ¹
Revenues	EUR 120m – 140m	EUR 530m – 600m
Gross Margin (%)		41% – 42%
EBIT Margin (%)		18% – 22%

- Gross Margin and EBIT Margin including EUR ~5m expense for personnel reduction measure in operations area
- Measure will result in mid-single-digit EURm annualized savings corresponding to ~1ppt Gross Margin and EBIT Margin improvement

Revenue Guidance FY/2025





Our Financial Calendar:

15 May 2025 31 Jul. 2025 30 Oct. 2025 Annual General Meeting
Q2/25 Results, Conference Call
Q3/25 Results, Conference Call

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Conferences & Roadshows:

19/20 May 21/22 May 27 May 11/12 June 1 July 26/27 Aug 28 Aug 03/04 Sept US East Coast Roadshow
Berenberg European Conference, New York
DSW Anlegerforum
BofA C-Suite TMT Conference, London
Roadshow Madrid
Jefferies Semiconductor Summit, Chicago
US Roadshow
TMT Conf., Commerzbank & Oddo, FFM

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For Dial-in Data, please refer to our website: www.aixtron.com/en/investors/events/conference-calls



24 Months Business Development



EUR million

Order Intake

(incl. equipment & after sales)¹

@ \$1.15

Q2

Q3

2023

Q4

Q1

@ \$1.15

@ \$1.10

178 118 118 120 143 157 132

Revenues

2023

(incl. equipment & after sales)²



2024

2025

Order Backlog

(equipment only)¹





Q2

2024

Q3

Q4

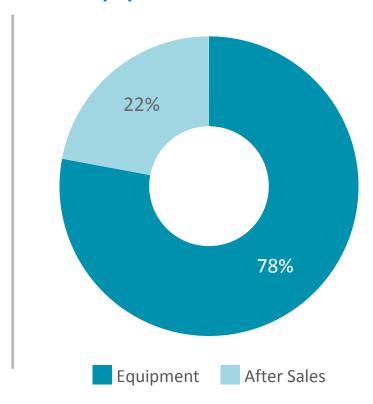
Q1

2025

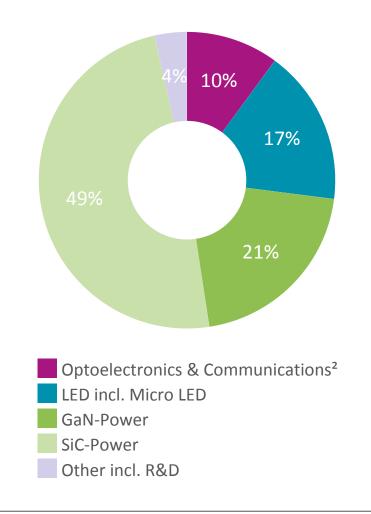
Q1/2025 Revenue Analysis¹



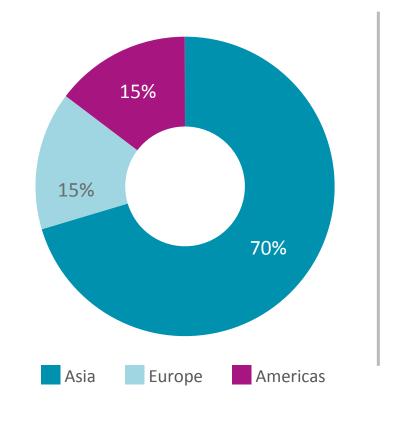
Equipment & After Sales



End Application (equipment only)



Regional Split

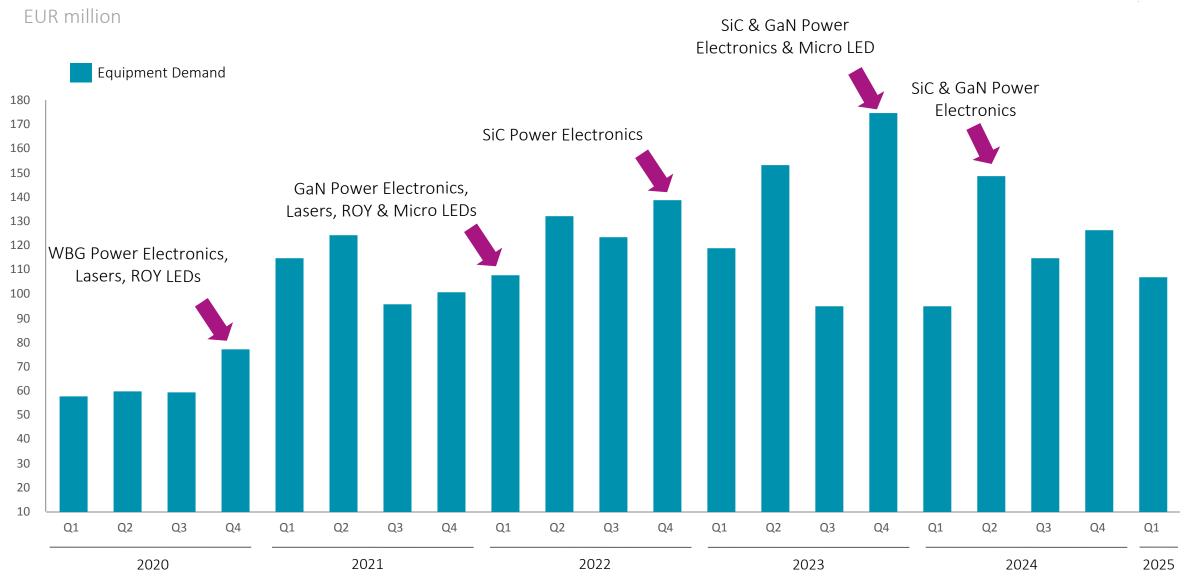


L Rounded figures; may not add t

² includes applications in Consumer Optoelectronics, Solar and Telecom/Datacom

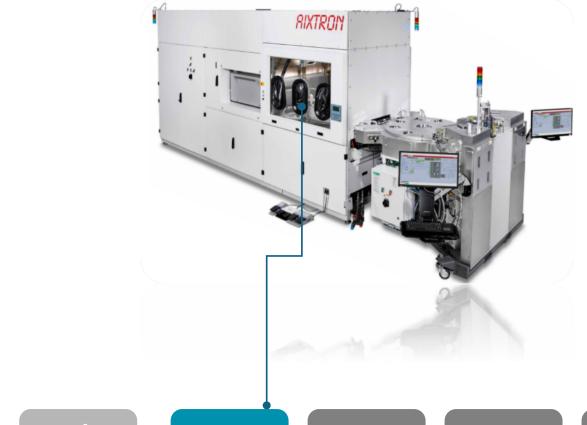
Demand Drivers on Order Intake per Quarter (Equipment Only)





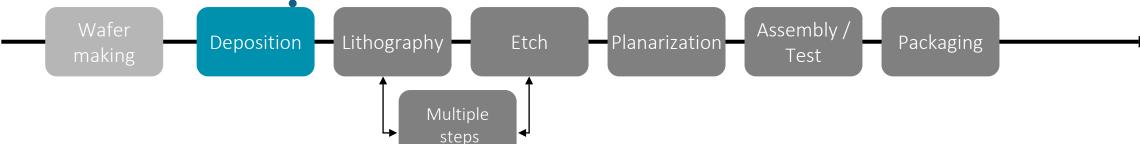
What We Do – deposition equipment for compound semiconductors





Focused Business Model

- AIXTRON is the leading supplier of <u>deposition</u> <u>equipment</u> to the <u>compound semiconductor</u> industry
- (MO)CVD: The tools run a (Metal-Organic) Chemical Vapor Deposition process for deposition of compound semiconductors
- Competitive strength comes from <u>strong focus</u> and clear <u>technology / market leadership</u> in <u>fast</u> <u>growing segments</u> of the market



Renewed product portfolio – strong market adoption of G10 tool family





- 9x150mm (6") or 6x200mm (8")
- Cost benefit of batch tool with uniformity on par with single wafer tool
- Highest productivity in the market
- End Markets/Products:
 Electric vehicles, charging infrastructure



- 8x150mm (6") or 5x200mm (8")
- Compact cluster for high volume
 GaN manufacturing
- Designed for replacement of Si power devices with GaN devices
- End Markets/Products:
 GaN Power Electronics & Wireless communication

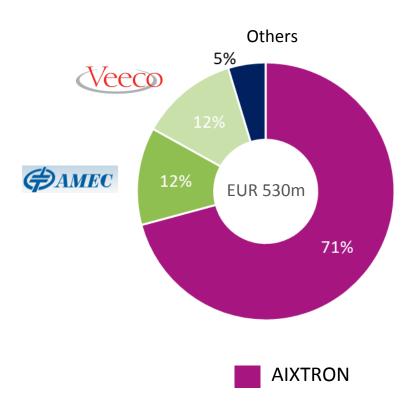


- 8x150mm (6") or 5x200mm (8")
- Fully automated AsP MOCVD system
- 10x lower defect density than predecessor tool
- End Markets/Products: Micro LED, Optical Communications, 3Dsensing & LiDAR

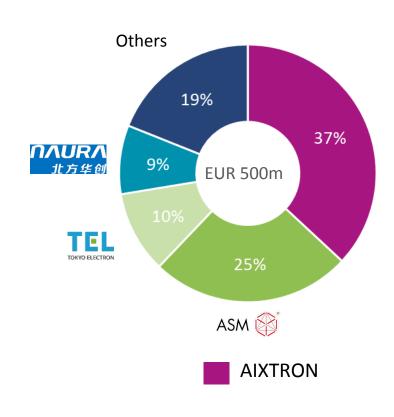
All G10 models now well established; G10-AsP gaining momentum in laser market



MOCVD (GaN/LED/Opto)



CVD (SiC)



Source: Gartner, own estimates Source: YOLE Power SiC - Manufacturing Report 2024

AIXTRON Competitive Landscape – clear market leader



		USA	Europe	China/Taiwan	Japan
Opto	GaAs/InP Lasers ROY (Micro) LED	Veeco		NAURA 北方华创	TAIYO NIPPON SANSO The Gas Professionals
	GaN (Micro) LED	Veeco		AMEC TOPEC	
Power	GaN Power	Veeco		EXAMPLE TOPEC	TAIYO NIPPON SANSO The Gas Professionals NUFLORE
	SiC Power		ASM 🔯	SISG TAURA ATTECH	TE L TOKYO ELECTRON

Consolidated Income Statement¹



(EUR million)	Q1/2025	Q1/2024	+/- (%)	Q1/2025	Q4/2024	+/- (%)
Revenues	112.5	118.3	(5)%	112.5	226.7	(50)%
Cost of sales	78.4	74.5	5%	78.4	124.3	(37)%
Gross profit	34.1	43.8	(22)%	34.1	102.5	(67)%
Gross margin	30%	37%	(7)pp	30%	45%	(15)pp
Selling expenses	4.8	3.7	30%	4.8	3.2	50%
General & admin expenses	9.1	7.6	20%	9.1	7.9	15%
R&D	17.7	22.9	(23)%	17.7	22.7	(22)%
Net other operating income	(0.7)	(0.4)	75%	(0.7)	(2.3)	(70)%
EBIT	3.3	9.9	(67)%	3.3	71.0	(95)%
EBIT margin	3%	8%	(5)pp	3%	31%	(28)pp
Net profit	5.1	10.8	(53)%	5.1	53.4	(90)%

- Q1/2025 Gross Profit & EBIT impacted by EUR ~5m expense for headcount reduction in operations area
- Adjusted Gross Margin at 35%
- Measure will result in mid-single-digit EURm annualized savings corresponding to ~1ppt Gross Margin and EBIT Margin improvement

Consolidated Balance Sheet¹



(EUR million)	31.03.25	31.12.24	30.09.24
Property, plant & equipment and leased assets	229.5	226.9	224.3
Goodwill	72.9	73.5	72.6
Other intangible assets	7.3	7.4	5.4
Other non-current assets	3.3	3.8	
Others	36.8	35.4	42.1
Non-current assets	349.9	347.1	344.5
Inventories	353.2	369.1	426.7
Trade receivables	134.0	193.4	116.4
Others	53.1	44.2	36.6
Cash & cash deposits & investments	93.3	64.6	78.1
Current assets	633.5	671.3	657.7
Equity	850.7	848.0	789.9
Non-current liabilities	8.4	7.5	7.3
Trade payables	21.2	33.9	39.0
Contract liabilities for advance payment	51.3	81.7	118.9
Others	51.8	47.3	47.2
Current liabilities	124.3	162.9	205.1
Balance sheet total	983.4	1,018.4	1,002.2

1 Rounded figures; may not add up

Consolidated Statement of Cash Flows¹



(EUR million)	Q1/2025	Q1/2024	Q1/2025	Q4/2024
Net result	5.1	10.8	5.1	53.4
Adjust for:				
Non-cash items	(1.5)	(10.4)	(1.5)	2.2
Changes in Working Capital ²	31.5	(7.8)	31.5	(57.6)
Cash flow from operating activities	35.1	(7.4)	35.1	(2.0)
Capital expenditures/disposals	(5.3)	(25.7)	(5.3)	(12.4)
Free cash flow	29.8	(33.1)	29.8	(14.4)
FX effects/other	(0.8)	0.4	(0.8)	1.3
Cash & cash deposits & investments	93.3	148.5	93.3	64.6

¹ Rounded figures; may not add up

² Working Capital = Inventories + Trade Receivables - Trade Payables - Contract Liabilities for Advance Payments; excl. FX-effects; updated definition applied to all periods

Four Year View on Consolidated Income Statement¹



(EUR million)	FY/24	FY/23	FY/22	FY/21
Revenues	633.2	629.9	463.2	429.0
Cost of sales	370.7	350.8	267.9	247.5
Gross profit	262.5	279.0	195.3	181.5
Gross margin	41%	44%	42%	42%
Selling expenses	14.2	14.1	11.2	10.0
General & admin expenses	31.9	32.6	29.2	25.4
R&D	91.4	87.7	57.7	56.8
Net other operating income	(6.2)	(12.1)	(7.6)	(9.7)
EBIT	131.2	156.8	104.7	99.0
EBIT margin	21%	25%	23%	23%
Net result	106.2	145.2	100.5	94.8

Four Year View on Consolidated Balance Sheet¹



(EUR million)	31.12.2024	31.12.2023	31.12.2022	31.12.2021
Property, plant & equipment and leased assets	226.9	147.8	99.0	74.0
Goodwill	73.5	72.3	72.5	72.3
Other intangible assets	7.4	4.4	3.3	2.2
Other non-current assets	3.8	0.0	0.0	0.0
Others	35.4	41.8	35.0	25.4
Non-current assets	347.1	266.3	209.7	174.0
Inventories	369.1	394.5	223.6	120.6
Trade receivables	193.4	157.6	119.7	81.0
Others	44.2	30.0	24.5	12.6
Cash & cash deposits & investments	64.6	181.7	325.2	352.5
Current Assets	671.3	763.7	692.9	566.7
Equity	848.0	777.6	663.3	592.2
Non-current liabilities	7.5	7.7	10.0	8.5
Trade payables	33.9	57.8	46.1	19.6
Contract liabilities for advance payment	81.7	141.3	141.2	77.0
Others	47.3	45.6	41.9	43.4
Current liabilities	162.9	244.6	229.3	140.1
Balance Sheet total	1,018.4	1,029.9	902.6	740.7

1 Rounded figures; may not add up

Four Year View on Consolidated Statement of Cash Flows¹



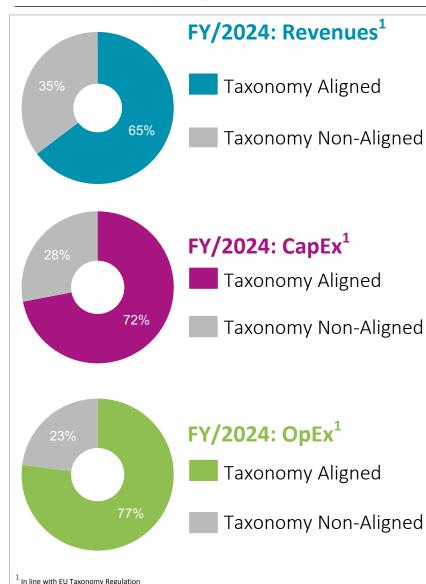
(EUR million)	FY/24	FY/23	FY/22	FY/21
Net Result	106.2	145.2	100.5	94.8
Adjust for:				
Non-Cash Items	9.1	4.3	(11.9)	18.3
Changes in Working Capital ²	(89.1)	(196.8)	(51.5)	(46.7)
Cash Flow from Operating Activities ²	26.2	(47.3)	37.1	66.4
Capital Expenditures/Disposals	(98.6)	(62.4)	(29.5)	(17.4)
Free Cash Flow	(72.4)	(109.7)	7.7	48.7
FX Effects/Other	1.3	(1.7)	(0.4)	3.2
Cash & cash deposits & investments	64.6	181.7	325.2	352.5

¹ Rounded figures; may not add u

² Working Capital = Inventories + Trade Receivables - Trade Payables - Contract Liabilities for Advance Payments; excl. FX-effects; updated definition applied to all periods

EU Taxonomy Alignment & ESG-Ratings – well above industry standard





EU Taxonomy Aligned Technologies

- Wide Band Gap (WBG) Power
 Semiconductors based on:
 - Gallium Nitride (GaN) and
 - Silicon Carbide (SiC)

Key technologies for energy-efficient Power Electronics

Micro LEDs:

For the next generation of displays

Laser Diodes for Data Communication:

Key technology for the digitalization of our world

Photovoltaics based on Compound Semiconductors:

For high-tech applications (e.g., space applications)

Quantum Technologies:

For neuromorphic computing and quantum sensing

ESG-Ratings

- CDP (Europe):
 - 2024: C
 - 2023: D
- MSCI:
 - 2024: AA
 - 2023: AA
- Sustainalytics:
 - 2024: 20.8 Medium risk
 - 2023: 19.2 Low risk
- ISS Oekom:
 - 2024: C
 - 2023: C-



AIXTRON

Our technology. Your future.

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